



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary (Typ. @ V_{GS} = -4.5V, T_A = +25°C)

BV _{DSS}	R _{DS(ON)}	Qg	Q_{gd}	l _D
-12V	0.065Ω	2.5nC	0.6nC	-3.3A

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Battery Management
- Load Switch
- Battery Protection



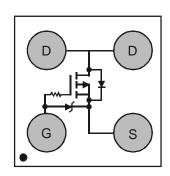
Features

- LD-MOS Technology with the Lowest Figure of Merit: $R_{DS(ON)} = 0.065\Omega \text{ to Minimize On-State Losses} \\ Q_g = 2.5nC \text{ for Ultra-Fast Switching}$
- V_{gs(TH)} = -0.5V Typ. for a Low Turn-On Potential
- CSP with Footprint 1.0mm x 1.0mm
- Height = 0.62mm for Low Profile
- ESD = 3kV HBM Protection of Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: U-WLB1010-4
- Terminal Connections: See Diagram Below
- Weight: 0.0018 grams (Approximate)

U-WLB1010-4



Top View Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMP1081UCB4-7	U-WLB1010-4	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

U-WLB1010-4



7A = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017) M = Month (ex: 9 = September)

Date Code Key

Year	201	6	2017		2018	20	19	2020		2021		2022
Code	D		Е		F	(G	Н				J
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	-12	V		
Gate-Source Voltage			V_{GSS}	-6	V
Continuous Drain Current (Note 5) V _{GS} = -4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-3.3 -2.7	А
Continuous Drain Current (Note 5) V _{GS} = -2.5V	I _D	-3.0 -2.4	А		
Pulsed Drain Current (Note 6)	I _{DM}	20	Α		

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	P _D	0.82	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 7)	$R_{\theta JA}$	150	°C/W
Thermal Resistance, Junction to Case @T _C = +25°C (Note 7)	R ₀ JC	42.66	°C/W
Power Dissipation (Note 5)	P _D	1.59	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 5)	$R_{\theta JA}$	80.29	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

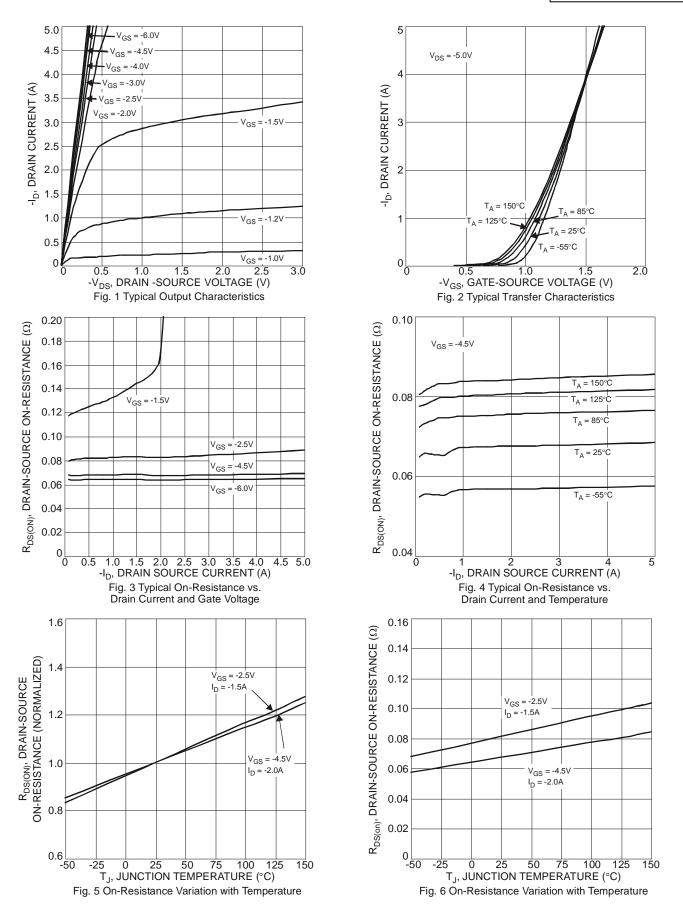
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 8)								
Drain-Source Breakdown Voltage	BV _{DSS}	-12	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$		
Gate-Source Breakdown Voltage	BV _{GSS}	-6.0	-	-	V	$V_{DS} = 0V, I_{G} = -250\mu A$		
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	-	-	-1	μΑ	$V_{DS} = -9.6V, V_{GS} = 0V$		
Gate-Source Leakage	I _{GSS}	-	-	-100	nA	$V_{GS} = -6V$, $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage	V _{GS(TH)}	-0.35	-0.5	-0.65	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$		
		-	0.065	0.08		$V_{GS} = -4.5V, I_D = -500mA$		
Static Drain-Source On-Resistance	B-s/s/	-	0.077	0.1	Ω	$V_{GS} = -2.5V$, $I_D = -500$ mA		
Static Diani-Source On-Nesistance	R _{DS(ON)}	-	0.108	0.13	22	$V_{GS} = -1.5V, I_D = -500mA$		
		-	0.4	10		$V_{GS} = -0.9V, I_D = -100mA$		
Forward Transfer Admittance	Y _{fs}	-	4	-	S	$V_{DS} = -6V, I_{D} = -500mA$		
Diode Forward Voltage	V_{SD}	-	-0.6	-1.0	V	$V_{GS} = 0V, I_{S} = -500mA$		
DYNAMIC CHARACTERISTICS (Note 9)								
Input Capacitance	C _{iss}	-	213	350		$V_{DS} = -6V, V_{GS} = 0V,$ f = 1.0MHz		
Output Capacitance	Coss	-	119	250	pF			
Reverse Transfer Capacitance	Crss	-	54.4	90		1 = 1.01/11/12		
Total Gate Charge	Q_g	-	2.5	5				
Gate-Source Charge	Qgs	1	0.3	1	nC	$V_{GS} = -4.5V, V_{DS} = -6V,$		
Gate-Drain Charge	Q_{gd}		0.6	-	110	$I_D = -500 \text{mA}$		
Gate Charge at V _{TH}	$Q_{g(TH)}$	1	0.15	1				
Turn-On Delay Time	t _{D(ON)}	-	16.7	-				
Turn-On Rise Time	t _R	-	20.6	-		$V_{DS} = -6V, V_{GS} = -2.5V,$		
Turn-Off Delay Time	t _{D(OFF)}	-	38.4	-	ns	$R_G = 20\Omega$, $I_D = -500 \text{mA}$		
Turn-Off Fall Time	t _F	-	28.4	-				
Reverse Recovery Charge	Q_{RR}	-	2.0	-	nC	$V_{DD} = -4.0V$, $I_F = -0.5A$,		
Reverse Recovery Time	t _{RR}	-	9.5	-	ns	di/dt =100A/µs		

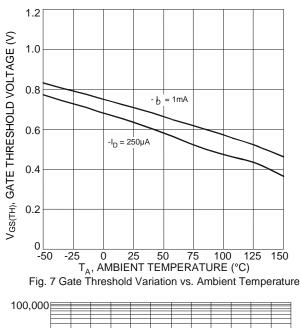
Notes:

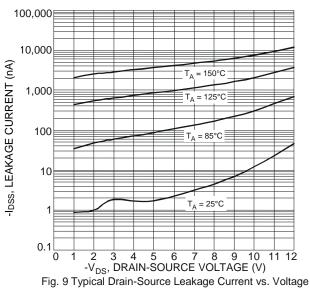
- Device mounted on FR-4 material with 1inch² (6.45cm²), 2oz. (0.071mm thick) Cu.
 Repetitive rating, pulse width limited by junction temperature.
 Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing.

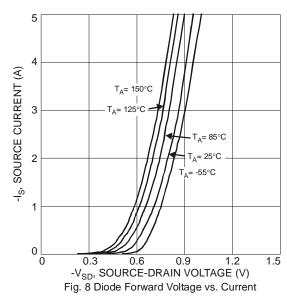


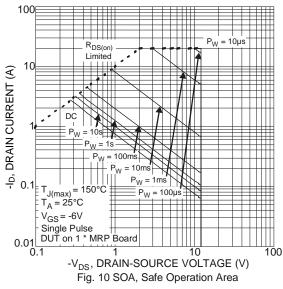


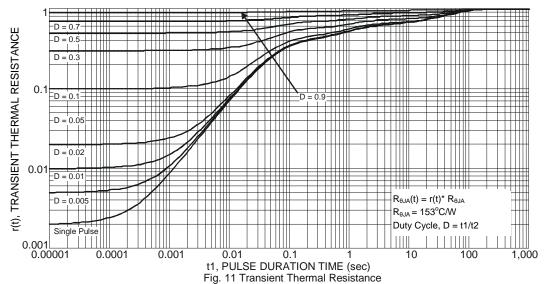










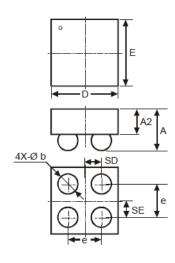




Package Outline Dimension

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-WLB1010-4

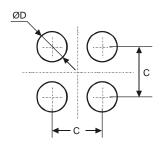


U-WLB1010-4							
Dim	Min	Max	Тур				
D	0.95	1.05	1.00				
Е	0.95	1.05	1.00				
Α	-	0.62	_				
A2	_	_	0.38				
b	0.25	0.35	0.30				
е	_	_	0.50				
SD	_	_	0.25				
SE	_	_	0.25				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-WLB1010-4



Dimensions	Value (in mm)
С	0.50
D	0.25



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